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Part Number: [2086592641](#)
Status: **Active**
Overview: iGrid Wire-to-Board Dual-Row System
Description: 2.00mm Pitch, iGrid PCB Header, Dual Row, Right-Angle, Through Hole, 0.10µm Gold (Au) Plating, Positive Lock, 26 Circuits, Tray, 3.20mm PC Tail Length, Black

Documents:

3D Model	Datasheet (PDF)
3D Model (PDF)	RoHS Certificate of Compliance (PDF)
Drawing (PDF)	

Agency Certification

UL E29179

General

Product Family	PCB Headers
Series	208659
Application	Signal, Wire-to-Board
Overview	iGrid Wire-to-Board Dual-Row System
Product Name	iGrid
UPC	193264111701

Physical

Breakaway	No
Circuits (Loaded)	26
Circuits (maximum)	26
Color - Resin	Black
Durability (mating cycles max)	30
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Keying to Mating Part	Yes
Lock to Mating Part	Yes
Material - Metal	Brass
Material - Plating Mating	Gold
Material - Resin	Polyamide
Net Weight	2045.000/mg
Number of Rows	2
Orientation	Right Angle
PC Tail Length	3.20mm
PCB Locator	Yes
PCB Retention	None
PCB Thickness - Recommended	1.20mm, 1.60mm
Packaging Type	Tray
Pitch - Mating Interface	2.00mm
Plating min - Mating	0.102µm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Stackable	No
Surface Mount Compatible (SMC)	No
Temperature Range - Operating	-40° to +105°C
Termination Interface: Style	Through Hole

Electrical

Current - Maximum per Contact	2.0A
Voltage - Maximum	250V AC (RMS)/DC

Material Info



Series image - Reference only

EU ELV

Not Relevant

EU RoHS

Compliant

REACH SVHC

Not Contained Per -
D(2020)4578-DC (25
June 2020)

Halogen-Free

Status

Not Low-Halogen

For more information, please visit [Contact US](#)

China ROHS

ELV

RoHS Phthalates

China RoHS

Green Image

Not Relevant

Not Contained

Search Parts in this Series

[208659](#) Series

Mates With

iGrid Receptacle Housing [501646](#)

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